

REVISIONS			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Correct propagation delay minimum limit in table I. – jak	00-08-22	Monica L. Poelking
B	Make change to footnote <u>g</u> in table I. Add vendor CAGE F8859. Add case outline X. Add device type 02. Add table III, delta limits. Change PRR in note 3 on figure 4. Update drawing to MIL-PRF-38535 requirements. Editorial changes throughout – jak	03-04-09	Thomas M. Hess
C	Update boilerplate paragraphs to the current MIL-PRF-38535 requirements. - LTG	09-10-23	Thomas M. Hess
D	Update boilerplate paragraphs to the current MIL-PRF-38535 requirements. Delete class M requirement throughout. - LTG	15-05-21	Thomas M. Hess
E	Update the boilerplate paragraphs to current requirements as specified in MIL-PRF-38535. - TTM	21-10-27	Muhammad A. Akbar

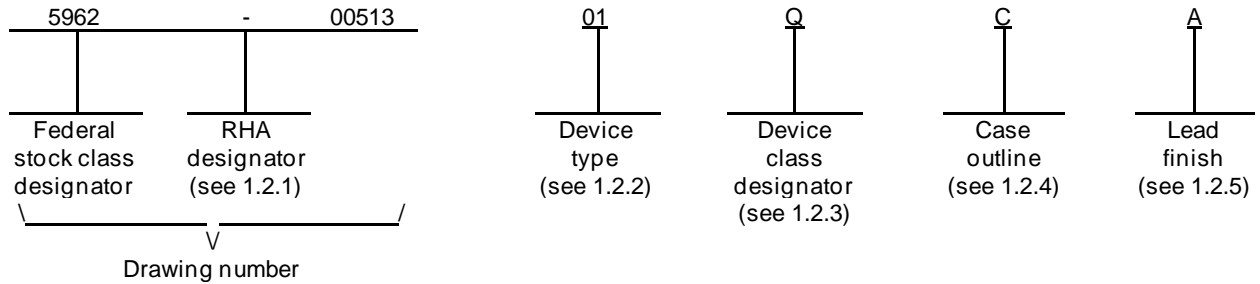


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PMIC N/A	PREPARED BY Joseph A. Kerby	DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 https://www.dla.mil/LandandMaritime																		
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A	CHECKED BY Charles F. Saffle, Jr.																			
	APPROVED BY Monica L. Poelking	MICROCIRCUIT, DIGITAL, ADVANCED CMOS, DUAL 4-INPUT NAND GATE, TTL COMPATIBLE INPUTS, MONOLITHIC SILICON																		
	DRAWING APPROVAL DATE 00-03-15																			
	REVISION LEVEL E	<table border="1"> <tr> <td>SIZE A</td> <td>CAGE CODE 67268</td> <td>5962-00513</td> </tr> <tr> <td colspan="2">SHEET</td> <td>1 OF 12</td> </tr> </table>	SIZE A	CAGE CODE 67268	5962-00513	SHEET		1 OF 12												
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1. SCOPE

1.1 Scope. This drawing documents two product assurance class levels consisting of high reliability (device class Q) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels is reflected in the PIN.

1.2 PIN. The PIN is as shown in the following example:



1.2.1 RHA designator. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	54ACT20	Dual 4-input NAND gate, TTL compatible inputs
02	54ACT20	Dual 4-input NAND gate, TTL compatible inputs

1.2.3 Device class designator. The device class designator is a single letter identifying the product assurance level as follows:

<u>Device class</u>	<u>Device requirements documentation</u>
Q or V	Certification and qualification to MIL-PRF-38535

1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
C	GDIP1-T14 or CDIP2-T14	14	Dual-in-line
X	CDFP3-F14	14	Flat pack

1.2.5 Lead finish. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V.

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1.3 Absolute maximum ratings. 1/ 2/ 3/

Supply voltage range (V_{CC})	-0.5 V dc to +6.0 V dc
DC input voltage range (V_{IN})	-0.5 V dc to $V_{CC} + 0.5$ V dc
DC output voltage range (V_{OUT})	-0.5 V dc to $V_{CC} + 0.5$ V dc
DC input clamp current (I_{IK}) ($V_{IN} < -0.5$ V or $V_{IN} > V_{CC} + 0.5$ V)	± 20 mA
DC output clamp current (I_{OK}) ($V_{OUT} < -0.5$ V or $V_{OUT} > V_{CC} + 0.5$ V)	± 50 mA
DC output source or sink current per output pin (I_{OUT})	± 50 mA
DC V_{CC} or ground current (I_{CC} or I_{GND})	± 100 mA
Storage temperature range (T_{STG})	-65°C to +150°C
Lead temperature (soldering, 10 seconds)	+300°C
Thermal resistance, junction-to-case (θ_{JC})	See MIL-STD-1835
Junction temperature (T_J)	+150°C
Maximum power dissipation (P_D)	500 mW

1.4 Recommended operating conditions. 2/ 3/

Supply voltage range (V_{CC})	+4.5 V dc to +5.5 V dc
Input voltage range (V_{IN})	+0.0 V dc to V_{CC}
Output voltage range (V_{OUT})	+0.0 V dc to V_{CC}
Minimum high level input voltage (V_{IH})	+2.0 V
Maximum low level input voltage (V_{IL})	+0.8 V
Maximum high level output current (I_{OH})	-24.0 mA
Maximum low level output current (I_{OL})	+24.0 mA
Maximum input rise or fall rate ($\Delta t/\Delta V$)	10 ns/V
Case operating temperature range (T_C)	-55°C to +125°C

- 1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
- 2/ Unless otherwise noted, all voltages are referenced to GND.
- 3/ The limits for the parameters specified herein shall apply over the fully specified V_{CC} range and case temperature range of -55°C to +125°C.

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
 MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
 MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <https://quicksearch.dla.mil/>.)

2.2 Non-Government publications. The following document(s) form a part of this document to the extent specified herein. Unless otherwise specified, the issues of these documents cited in the solicitation or contract.

JEDEC – SOLID STATE TECHNOLOGY ASSOCIATION (JEDEC)

JESD20 - Standard for Description of 54/74ACXXXXX and 54/74ACTXXXXX Advanced High-Speed CMOS Devices.

(Copies of these documents are available online at <https://www.jedec.org/>.)

(Non-Government standards and other publications are normally available from the organizations that prepare or distribute the documents. These documents may also be available in or through libraries or other informational services.)

2.3 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 as specified herein, or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.4 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Truth table. The truth table shall be as specified on figure 2.

3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.

3.2.5 Switching waveforms and test circuit. The switching waveforms and test circuit shall be as specified on figure 4.

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3.3 Electrical performance characteristics and postirradiation parameter limits. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full case operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.

3.5 Marking. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535.

3.5.1 Certification/compliance mark. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535.

3.6 Certificate of compliance. For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). The certificate of compliance submitted to DLA Land and Maritime-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein.

3.7 Certificate of conformance. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 shall be provided with each lot of microcircuits delivered to this drawing.

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TABLE I. Electrical performance characteristics.

Test and MIL-STD-883 test method <u>1/</u>	Symbol	Test conditions <u>2/</u> -55°C ≤ T _C ≤ +125°C +4.5 V ≤ V _{CC} ≤ +5.5 V unless otherwise specified	Device type and device class <u>3/</u>	V _{CC}	Group A subgroups	Limits <u>4/</u>		Unit
						Min	Max	
Positive input clamp voltage 3022	V _{IC+}	For input under test I _{IN} = 1.0 mA	All V	0.0 V	1	0.4	1.5	V
Negative input clamp voltage 3022	V _{IC-}	For input under test I _{IN} = -1.0 mA	All V	Open	1	-0.4	-1.5	V
High level output voltage 3006	V _{OH}	V _{IN} = V _{IH} = 2.0 V or V _{IL} = 0.8 V I _{OH} = -50 μA	All All	4.5 V	1, 2, 3	4.4		V
			02 All	5.5V		5.4		
		V _{IN} = V _{IH} = 2.0 V or V _{IL} = 0.8 V I _{OH} = -24 mA	All All	4.5 V	1	3.94		
			02 All	5.5 V	1	4.86		
		V _{IN} = V _{IH} = 2.0 V or V _{IL} = 0.8 V I _{OH} = -50 mA <u>5/</u>	All All	5.5 V	2, 3	3.85		
Low level output voltage 3007	V _{OL}	V _{IN} = V _{IH} = 2.0 V or V _{IL} = 0.8 V I _{OL} = +50 μA	All All	4.5 V	1, 2, 3		0.1	V
			02 All	5.5 V	1, 2, 3		0.1	
		V _{IN} = V _{IH} = 2.0 V or V _{IL} = 0.8 V I _{OL} = +24 mA	All All	4.5 V	1		0.36	
			02 All	5.5 V	1		0.36	
		V _{IN} = V _{IH} = 2.0 V or V _{IL} = 0.8 V I _{OL} = +50 mA <u>5/</u>	All All	5.5 V	2, 3		1.65	
Input leakage current high 3010	I _{IH}	For input under test V _{IN} = 5.5 V For all other inputs V _{IN} = V _{CC} or GND	All All	5.5 V	1		+0.1	μA
					2, 3		+1.0	
Input leakage current low 3009	I _{IL}	For input under test V _{IN} = 0.0 V For all other inputs V _{IN} = V _{CC} or GND	All All	5.5 V	1		-0.1	μA
					2, 3		-1.0	
Quiescent supply current delta, TTL input levels 3005	ΔI _{CC} <u>6/</u>	For input under test V _{IN} = V _{CC} - 2.1 V For all other inputs V _{IN} = V _{CC} or GND	01 All	4.5 V and 5.5 V	1		648.0	μA
			02 All		5.5 V	1, 2, 3		
Quiescent supply current 3005	I _{CC}	For all inputs V _{IN} = V _{CC} or GND I _{OUT} = 0.0 V	All All	5.5 V	1		4.0	μA
					2, 3		80.0	
Input capacitance 3012	C _{IN}	See 4.4.1c T _C = +25°C	All All	GND	4		10.0	pF

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test and MIL-STD-883 test method <u>1/</u>	Symbol	Test conditions <u>2/</u> -55°C ≤ T _C ≤ +125°C +4.5 V ≤ V _{CC} ≤ +5.5 V unless otherwise specified	Device type and device class <u>3/</u>	V _{CC}	Group A subgroups	Limits <u>4/</u>		Unit
						Min	Max	
Power dissipation capacitance	C _{PD} <u>7/</u>	See 4.4.1c T _C = +25°C, f = 1 MHz	All All	5.0 V	4		48.0	pF
Functional tests 3014	<u>8/</u>	See 4.4.1b V _{IN} = V _{IH} = 2.0 V or V _{IL} = 0.8 V Verify output V _{OUT}	All	4.5 V	7, 8	L	H	
			All	5.5 V	7, 8	L	H	
Propagation delay time, mA, mB, mC, or mD to mY 3003	t _{PHL} , t _{PLH} <u>9/</u>	C _L = 50 pF R _L = 500Ω See figure 4	All All	4.5 V	9, 10, 11	1.0	13.5	ns

- 1/ For tests not listed in the referenced MIL-STD-883 (e.g. ΔI_{CC}), utilize the general test procedure of 883 under the conditions listed herein.
- 2/ Each input/output, as applicable, shall be tested at the specified temperature, for the specified limits, to the tests in table I herein. Output terminals not designated shall be high-level logic, low-level logic, or open, except for all I_{CC} and ΔI_{CC} tests, where the output terminals shall be open. When performing the I_{CC} and ΔI_{CC} tests, the current meter shall be placed in the circuit such that all current flows through the meter.
- 3/ The word "All" in the device type and device class column, means limits for all device types and classes.
- 4/ For negative and positive voltage and current values, the sign designates the potential difference in reference to GND and the direction of current flow, respectively; and the absolute value of the magnitude, not the sign, is relative to the minimum and maximum limits, as applicable, listed herein.
- 5/ Test one output at a time for a 1 second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation. Test verifies a minimum 75Ω transmission-line-drive capability.
- 6/ This test may be performed either one input at a time (preferred method) or with all input pins simultaneously at V_{IN} = V_{CC} - 2.1 V (alternate method). Classes Q and V shall use the preferred method. When the test is performed using the alternate test method, the maximum limit is equal to the number of inputs at a high TTL input level times ΔI_{CC} max., and the preferred method and limits are guaranteed.
- 7/ Power dissipation capacitance (C_{PD}) determines both the power consumption (P_D) and current consumption (I_S). Where:

$$P_D = (C_{PD} + C_L) (V_{CC} \times V_{CC})f + (I_{CC} \times V_{CC}) + (n \times d \times \Delta I_{CC} \times V_{CC})$$

$$I_S = (C_{PD} + C_L) V_{CC}f + I_{CC} + (n \times d \times \Delta I_{CC})$$
 f is the frequency of the input signal; n is the number of device inputs at TTL levels; d is the duty cycle of the input signal; and C_L is the external output load capacitance.
- 8/ Tests shall be performed in sequence, attributes data only. Functional tests shall include the truth table and other logic patterns used for fault detection. The test vectors used to verify the truth table shall, at a minimum, test all functions of each input and output. All possible input to output logic patterns per function shall be guaranteed, if not tested, to the truth table in figure 2 herein. Functional tests shall be performed in sequence as approved by the qualifying activity on qualified devices. Allowable tolerances per MIL-STD-883 may be incorporated. For outputs, L ≤ 0.8 V, H ≥ 2.0 V.
- 9/ AC limits at V_{CC} = 5.5 V are equal to the limits at V_{CC} = 4.5 V and guaranteed by testing at V_{CC} = 4.5 V. Minimum propagation delay limits for V_{CC} = 5.5 V shall be guaranteed to be no more than 0.5 ns less than those specified at V_{CC} = 4.5 V in table I herein. For propagation delay tests, all paths must be tested.

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Device type	All
Case outlines	C, X
Terminal number	Terminal symbol
1	1A
2	1B
3	NC
4	1C
5	1D
6	1Y
7	GND
8	2Y
9	2A
10	2B
11	NC
12	2C
13	2D
14	V _{cc}

NC = No internal connection

FIGURE 1. Terminal connections.

Inputs				Outputs
mA	mB	mC	mD	mY
L	X	X	X	H
X	L	X	X	H
X	X	L	X	H
X	X	X	L	H
H	H	H	H	L

H = High voltage level
L = Low voltage level
X = Irrelevant

FIGURE 2. Truth table.

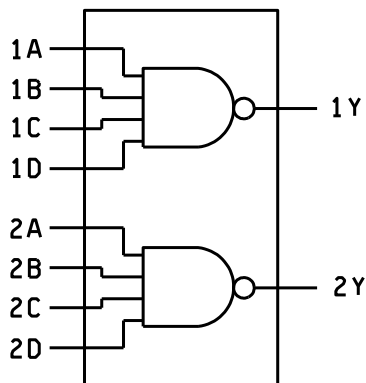


FIGURE 3. Logic diagram.

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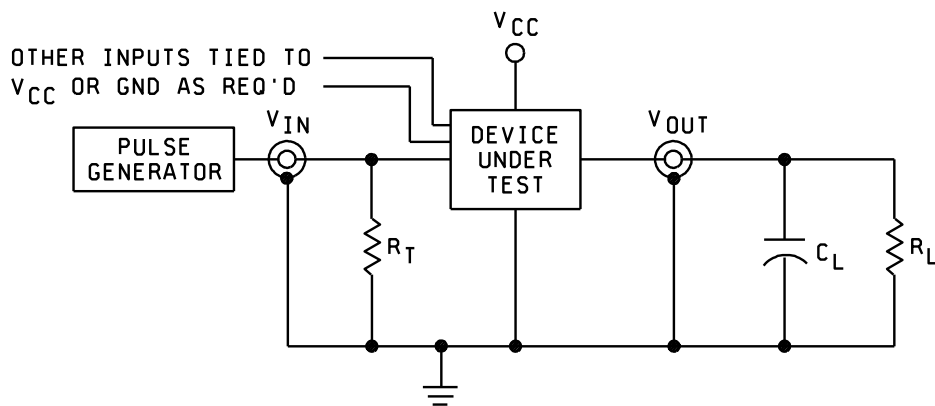
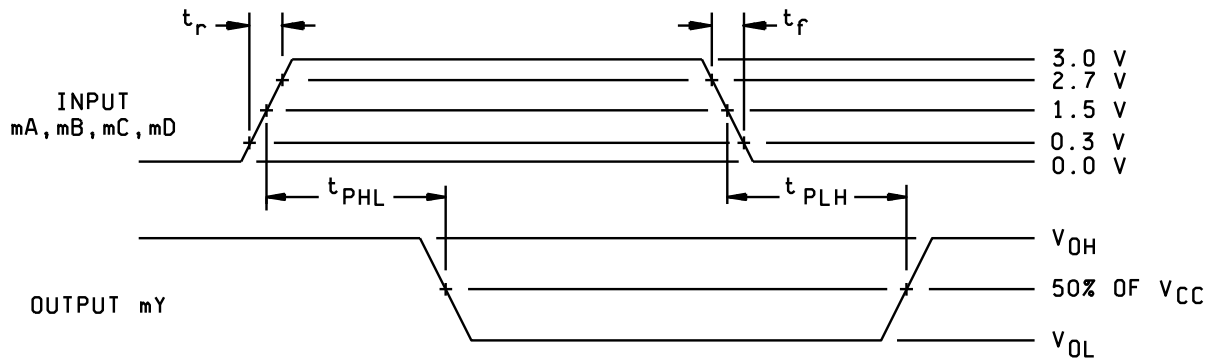
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NOTES:

1. $C_L = 50 \text{ pF}$ minimum or equivalent (includes test jig and probe capacitance).
2. $R_T = 50\Omega$, $R_L = 500\Omega$ or equivalent.
3. Input signal from pulse generator: $V_{IN} = 0.0 \text{ V}$ to 3.0 V ; $\text{PRR} \leq 10 \text{ MHz}$; $t_r = 3.0 \text{ ns}$; $t_f = 3.0 \text{ ns}$; t_r and t_f shall be measured from 0.3 V to 2.7 V and from 2.7 V to 0.3 V , respectively; duty cycle = 50 percent.
4. Timing parameters shall be tested at a minimum input frequency of 1 MHz .
5. The outputs are measured one at a time with one transition per measurement.

FIGURE 4. Switching waveforms and test circuit.

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4. VERIFICATION

4.1 Sampling and inspection. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

4.2 Screening. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection.

4.2.1 Additional criteria for device classes Q and V.

- a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table II herein.
- c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.

4.3 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4 Conformance inspection. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections, and as specified herein.

4.4.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. For device classes Q and V, subgroups 7 and 8 shall include verifying the functionality of the device.
- c. C_{IN} and C_{PD} shall be measured only for initial qualification and after process or design changes which may affect capacitance. C_{IN} shall be measured between the designated terminal and GND at a frequency of 1 MHz. C_{PD} shall be tested in accordance with the latest revision of JEDEC Standard No. 20 and table I herein. For C_{IN} and C_{PD} , test all applicable pins on five devices with zero failures.

4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table II herein.

4.4.2.1 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

Test requirements	Subgroups (in accordance with MIL-PRF-38535, table III)	
	Device class Q	Device class V
Interim electrical parameters (see 4.2)	---	1
Final electrical parameters (see 4.2)	<u>1/</u> 1, 2, 3, 7, 8, 9, 10, 11	<u>2/</u> <u>3/</u> 1, 2, 3, 7, 8, 9, 10, 11
Group A test requirements (see 4.4)	1, 2, 3, 4, 7, 8, 9, 10, 11	1, 2, 3, 4, 7, 8, 9, 10, 11
Group C end-point electrical parameters (see 4.4)	1, 2, 3	<u>3/</u> 1, 2, 3, 7,8, 9, 10, 11
Group D end-point electrical parameters (see 4.4)	1, 2, 3	1, 2, 3
Group E end-point electrical parameters (see 4.4)	1, 7, 9	1, 7, 9

1/ PDA applies to subgroup 1.

2/ PDA applies to subgroups 1 and 7, and deltas.

3/ Delta limits as specified in table III shall be required where specified, and the delta limits shall be completed with reference to the zero hour electrical parameters.

TABLE III. Burn-in and operating life test, delta parameters (+25°C).

Parameter <u>1/</u>	Symbol	Device type	Delta Limits
Supply current	I _{CC}	02	±150 nA
Supply current delta	ΔI _{CC}	02	±0.4 mA
Input current low level	I _{IL}	02	±20 nA
Input current high level	I _{IH}	02	±20 nA
Output voltage low level (V _{CC} = 5.5 V, I _{OL} = +24 mA)	V _{OL}	02	±0.04 V
Output voltage high level (V _{CC} = 5.5 V, I _{OH} = -24 mA)	V _{OH}	02	±0.20 V

1/ These parameters shall be recorded before and after the required burn-in and life tests to determine delta limits.

4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table II herein.

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4.4.4 Group E inspection. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).

- a. End-point electrical parameters shall be as specified in table II herein.
- b. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535 for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at $T_A = +25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, after exposure, to the subgroups specified in table II herein.

4.5 Methods of inspection. Methods of inspection shall be specified as follows:

4.5.1 Voltage and current. Unless otherwise specified, all voltages given are referenced to the microcircuit GND terminal. Currents given are conventional current and positive when flowing into the referenced terminal.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.1.1 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor prepared specification or drawing.

6.2 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.3 Record of users. Military and industrial users should inform DLA Land and Maritime when a system application requires configuration control and which SMD's are applicable to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DLA Land and Maritime-VA, telephone (614) 692-8108.

6.4 Comments. Comments on this drawing should be directed to DLA Land and Maritime-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0591.

6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.

6.6 Sources of supply.

6.6.1 Sources of supply for device classes Q and V. Sources of supply for device classes Q and V are listed in MIL-HDBK-103 and QML-38535. The vendors listed in MIL-HDBK-103 and QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DLA Land and Maritime-VA and have agreed to this drawing.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-00513
		REVISION LEVEL E	SHEET 12

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 21-10-27

Approved sources of supply for SMD 5962-00513 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at <https://landandmaritimeapps.dla.mil/programs/smcr/>.

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
5962-0051301QCA	01295	CD54ACT20F3A
5962-0051302QXA	<u>3/</u>	54ACT20K02Q
5962-0051302QXC	<u>3/</u>	54ACT20K01Q
5962-0051302VXA	<u>3/</u>	54ACT20K02V
5962-0051302VXC	<u>3/</u>	54ACT20K01V

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.

2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

3/ Not available from an approved source of supply.

Vendor CAGE number

01295

Vendor name and address

Texas Instruments, Inc.
Semiconductor Group
8505 Forest Ln.
P.O. Box 660199
Dallas, TX 75243

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.